The S-19190 Series is a voltage monitoring IC with a cell balancing function and includes a high-accuracy voltage detection circuit and a delay circuit.
The S-19190 Series is suitable for cell balancing and overcharge protection of batteries and capacitors.

## Caution This product can be used in vehicle equipment and in-vehicle equipment. Before using the product for these purposes, it is imperative to contact our sales representatives.

## Features

- High-accuracy voltage detection circuit Cell balancing detection voltage: 2.0 V to 4.6 V ( 5 mV step)

$$
\text { Accuracy } \pm 12 \mathrm{mV}\left(2.0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{BU}}<2.4 \mathrm{~V}\right)
$$

Accuracy $\pm 0.5 \%$ ( $2.4 \mathrm{~V} \leq \mathrm{V}_{\text {BU }} \leq 4.6 \mathrm{~V}$ )
Cell balancing release voltage: $\quad 2.0 \mathrm{~V}$ to $4.6 \mathrm{~V}^{* 1}$
Overcharge detection voltage: $\quad 2.0 \mathrm{~V}$ to $4.6 \mathrm{~V}(5 \mathrm{mV}$ step $)$
Accuracy $\pm 24 \mathrm{mV}\left(2.0 \mathrm{~V} \leq \mathrm{V}_{\text {BL }}<2.4 \mathrm{~V}\right)$
Accuracy $\pm 1.0 \%\left(2.4 \mathrm{~V} \leq \mathrm{V}_{\mathrm{BL}} \leq 4.6 \mathrm{~V}\right)$
Accuracy $\pm 12 \mathrm{mV}\left(2.0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{cu}}<2.4 \mathrm{~V}\right)$
Accuracy $\pm 0.5 \%(2.4 \mathrm{~V} \leq \mathrm{Vcu} \leq 4.6 \mathrm{~V})$
Overcharge release voltage: $\quad 2.0 \mathrm{~V}$ to $4.6 \mathrm{~V}^{*}{ }^{2}$
Accuracy $\pm 24 \mathrm{mV}\left(2.0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CL}}<2.4 \mathrm{~V}\right)$
Accuracy $\pm 1.0 \%\left(2.4 \mathrm{~V} \leq \mathrm{V}_{\mathrm{cL}} \leq 4.6 \mathrm{~V}\right)$

- Built-in Nch transistor with ON resistance of $5 \Omega$ typ. between the CB pin and the VSS pin
- Current consumption:
$2.0 \mu \mathrm{~A}$ max. $\left(\mathrm{Ta}=+25^{\circ} \mathrm{C}\right)$
- Delay times are generated only by an internal circuit (External capacitors are unnecessary).
- CO pin output form and output logic are selectable: CMOS output Active "H", active "L" Nch open-drain output Active "H", active "L"
- Switchable to power-saving mode by using the $\overline{C E}$ pin
- Operation temperature range: $\mathrm{Ta}=-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$
- Lead-free (Sn 100\%), halogen-free
- AEC-Q100 qualified ${ }^{* 3}$
*1. Cell balancing release voltage $=$ Cell balancing detection voltage - Cell balancing hysteresis voltage (Cell balancing hysteresis voltage can be selected as 0 V or from a range of 0.1 V to 0.7 V in 50 mV step.)
*2. Overcharge release voltage $=$ Overcharge detection voltage - Overcharge hysteresis voltage (Overcharge hysteresis voltage can be selected as 0 V or from a range of 0.1 V to 0.7 V in 50 mV step.)
*3. Contact our sales representatives for details.


## Applications

- Rechargeable battery module
- Capacitor module


## Package

- SOT-23-6


## ■ Block Diagram


*1. All diodes shown in the figure are parasitic diodes.
Figure 1

## ■ AEC-Q100 Qualified

This IC supports AEC-Q100 for operation temperature grade 2.
Contact our sales representatives for details of AEC-Q100 reliability specification.

## ■ Product Name Structure

1. Product name

*1. Refer to the tape drawing.
2. Package

Table 1 Package Drawing Codes

| Package Name | Dimension | Tape | Reel |
| :---: | :---: | :---: | :---: |
| SOT-23-6 | MP006-A-P-SD | MP006-A-C-SD | MP006-A-R-SD |

3. Product name list

Table $2(2 / 1)$

| Product Name | Cell Balancing <br> Detection <br> Voltage $\left[\mathrm{V}_{\mathrm{BU}}\right]$ | Cell Balancing <br> Release <br> Voltage <br> [VBL] | Overcharge <br> Detection <br> Voltage $\left[\mathrm{V}_{\mathrm{cu}}\right]$ | Overcharge <br> Release <br> Voltage $\left[\mathrm{V}_{\mathrm{CL}}\right]$ | CO Pin <br> Output Form | CO Pin <br> Output Logic | Combination of Delay Time |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| S-19190AAH-M6T1U | 2.600 V | 2.600 V | 2.750 V | 2.750 V | CMOS output | Active "H" | (1) |
| S-19190ABH-M6T1U | 3.000 V | 3.000 V | 3.150 V | 3.150 V | CMOS output | Active "H" | (1) |
| S-19190ACH-M6T1U | 3.000 V | 3.000 V | 3.200 V | 3.200 V | CMOS output | Active "H" | (1) |
| S-19190ADH-M6T1U | 3.100 V | 3.100 V | 3.250 V | 3.250 V | CMOS output | Active "H" | (1) |
| S-19190AEH-M6T1U | 3.100 V | 3.100 V | 3.300 V | 3.300 V | CMOS output | Active "H" | (1) |
| S-19190AFH-M6T1U | 2.600 V | 2.600 V | 2.800 V | 2.800 V | CMOS output | Active "H" | (1) |
| S-19190AGH-M6T1U | 2.400 V | 2.400 V | 2.900 V | 2.900 V | CMOS output | Active "H" | (1) |
| S-19190AHH-M6T1U | 2.400 V | 2.400 V | 3.000 V | 3.000 V | CMOS output | Active "H" | (1) |
| S-19190AIH-M6T1U | 2.100 V | 2.100 V | 3.000 V | 3.000 V | CMOS output | Active "H" | (1) |
| S-19190AKH-M6T1U | 2.400 V | 2.400 V | 3.200 V | 3.200 V | CMOS output | Active "H" | (1) |
| S-19190ALH-M6T1U | 2.100 V | 2.000 V | 3.200 V | 3.200 V | CMOS output | Active "H" | (1) |
| S-19190AMH-M6T1U | 2.620 V | 2.520 V | 2.800 V | 2.700 V | CMOS output | Active "H" | (1) |
| S-19190ANH-M6T1U | 3.300 V | 3.300 V | 4.080 V | 3.930 V | CMOS output | Active "H" | (1) |
| S-19190AOH-M6T1U | 2.000 V | 2.000 V | 3.000 V | 3.000 V | CMOS output | Active "H" | (1) |
| S-19190APH-M6T1U | 3.700 V | 3.700 V | 4.500 V | 4.500 V | CMOS output | Active "H" | (1) |
| S-19190AQH-M6T1U | 3.800 V | 3.800 V | 4.080 V | 3.930 V | CMOS output | Active "H" | (1) |
| S-19190ARH-M6T1U | 2.800 V | 2.800 V | 3.150 V | 3.150 V | CMOS output | Active "H" | (1) |

Table 2 (2 / 2)

| Product Name | Cell Balancing <br> Detection Voltage [VBu] | Cell Balancing <br> Release <br> Voltage <br> [VBL] | Overcharge Detection Voltage [Vcu] | Overcharge <br> Release <br> Voltage <br> [ V cl] | CO Pin Output Form | CO Pin Output Logic | Combination of Delay Time |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| S-19190ASH-M6T1U | 2.800 V | 2.800 V | 3.200 V | 3.200 V | CMOS output | Active "H" | (1) |
| S-19190ATH-M6T1U | 2.800 V | 2.800 V | 3.100 V | 3.100 V | CMOS output | Active "H" | (1) |
| S-19190AUH-M6T1U | 2.500 V | 2.400 V | 3.800 V | 3.700 V | CMOS output | Active "H" | (1) |
| S-19190AVH-M6T1U | 2.300 V | 2.200 V | 3.800 V | 3.700 V | CMOS output | Active "H" | (1) |
| S-19190AWH-M6T1U | 2.650 V | 2.600 V | 2.750 V | 2.650 V | Nch open-drain output | Active "L" | (1) |
| S-19190AXH-M6T1U | 2.400 V | 2.400 V | 2.950 V | 2.950 V | CMOS output | Active "H" | (1) |
| S-19190AYH-M6T1U | 4.150 V | 4.150 V | 4.275 V | 4.275 V | CMOS output | Active "H" | (2) |
| S-19190AZH-M6T1U | 2.450 V | 2.450 V | 2.500 V | 2.500 V | CMOS output | Active "H" | (3) |
| S-19190BCH-M6T1U | 4.200 V | 4.200 V | 4.300 V | 4.200 V | CMOS output | Active "L" | (5) |
| S-19190BDH-M6T1U | 2.300 V | 2.300 V | 2.600 V | 2.600 V | CMOS output | Active "H" | (1) |
| S-19190BEH-M6T1U | 4.400 V | 4.200 V | 4.600 V | 4.600 V | CMOS output | Active "H" | (3) |
| S-19190BFH-M6T1U | 3.550 V | 3.200 V | 4.080 V | 3.380 V | CMOS output | Active "L" | (4) |
| S-19190BGH-M6T1U | 2.700 V | 2.000 V | 4.400 V | 3.700 V | CMOS output | Active "H" | (3) |
| S-19190BHH-M6T1U | 3.550 V | 3.550 V | 3.800 V | 3.700 V | CMOS output | Active "L" | (4) |
| S-19190BIH-M6T1U | 2.700 V | 2.000 V | 4.400 V | 4.200 V | CMOS output | Active "H" | (3) |
| S-19190BJH-M6T1U | 2.725 V | 2.675 V | 2.775 V | 2.725 V | CMOS output | Active "L" | (4) |
| S-19190BKH-M6T1U | 2.700 V | 2.000 V | 4.080 V | 3.930 V | CMOS output | Active "H" | (3) |

Remark 1. Please contact our sales representatives for products other than the above.
2. Set $\mathrm{V}_{\mathrm{c}}>\mathrm{V}_{\mathrm{b}}$.
3. Refer to Table 3 for details about combinations of delay times.

Table 3

| Combination of <br> Delay Time | Cell Balancing <br> Detection Delay Time <br> [ $\mathrm{t}_{\mathrm{BU}}$ ] | Cell Balancing <br> Release Delay Time <br> [tBL] | Overcharge <br> Detection Delay Time <br> [tcu] | Overcharge Release <br> Delay Time <br> [tcL] |
| :---: | :---: | :---: | :---: | :---: |
| $(1)$ | 128 ms | 1.0 ms | 128 ms | 1.0 ms |
| $(2)$ | 128 ms | 1.0 ms | 1024 ms | 1.0 ms |
| $(3)$ | 64 ms | 0.5 ms | 64 ms | 0.5 ms |
| $(4)$ | 128 ms | 1.0 ms | 1024 ms | 2.0 ms |
| $(5)$ | 64 ms | 2.0 ms | 256 ms | 1.0 ms |

Remark The delay times can be changed within the ranges listed above. For details, please contact our sales representatives.

Table 4

| Delay Time | Symbol | Selection Range |  |  |  |  | Remark |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Cell balancing detection delay time* ${ }^{*}$ | $t_{B U}$ | 64 ms | $128 \mathrm{~ms}^{*}{ }^{2}$ | 256 ms | 512 ms | 1024 ms | Select a value from the left. |
| Cell balancing release delay time | $t_{B L}$ | 0.5 ms |  | $1.0 \mathrm{~ms}^{* 2}$ | 2.0 ms |  | Select a value from the left. |
| Overcharge detection delay time ${ }^{* 1}$ | tcu | 64 ms | $128 \mathrm{~ms}^{*}{ }^{2}$ | 256 ms | 512 ms | 1024 ms | Select a value from the left. |
| Overcharge release delay time | tcL | 0.5 ms |  | $1.0 \mathrm{~ms}^{* 2}$ |  | 0 ms | Select a value from the left. |

*1. Set $\mathrm{t}_{\mathrm{c} u} \geq \mathrm{t}_{\mathrm{Bu}}$.
*2. The value is the delay time of the standard products.

## ■ Pin Configuration

1．SOT－23－6

| Top view | Table 5 |  |  |
| :---: | :---: | :---: | :---: |
|  | Pin No． | Symbol | Description |
|  | 1 | CO | Output pin for overcharge signal |
| $\begin{array}{rrr} 6 & 5 & 4 \\ \text { 日 日 日 } \\ \hline \hline \end{array}$ | 2 | VSS | Input pin for negative power supply |
|  | 3 | DP | Test mode switching pin <br> ＂H＂：Test mode（used to shorten the delay time） <br> ＂L＂：Normal operation mode |
|  | 4 | $\overline{C E}$ | Power－saving mode switching pin <br> ＂H＂：Power－saving mode <br> ＂L＂：Normal operation mode |
| Figure 2 | 5 | VDD | Input pin for positive power supply |
|  | 6 | CB | Output pin for cell balancing signal （Nch open－drain output） |

## ■ Absolute Maximum Ratings

Table 6

| Item | Symbol | Applied Pin | Absolute Maximum Rating | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Input voltage between VDD pin and VSS pin | VDs | VDD | Vss -0.3 to $V_{s s}+6.0$ | V |
| Input pin voltage | VIn | CE, DP | $\mathrm{V}_{s s}-0.3$ to $\mathrm{V}_{\mathrm{dD}}+0.3 \leq \mathrm{V}_{\text {ss }}+6.0$ | V |
| Output pin voltage | Vout | CO, CB | $\mathrm{V}_{\text {ss }}-0.3$ to $\mathrm{V}_{\text {dD }}+0.3 \leq \mathrm{V}_{\text {ss }}+6.0$ | V |
| Output pin current | $\mathrm{I}_{\text {cb }}$ | CB | $100\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+105^{\circ} \mathrm{C}\right)$ | mA |
| Operation ambient temperature | Topr | - | -40 to +105 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature | $\mathrm{T}_{\text {stg }}$ | - | -55 to +125 | ${ }^{\circ} \mathrm{C}$ |

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

## ■ Thermal Resistance Value

Table 7

| Item | Symbol | Condition |  | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Junction-to-ambient thermal resistance** | $\theta_{\text {JA }}$ | SOT-23-6 | Board A | - | 159 | - | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  |  |  | Board B | - | 124 | - | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  |  |  | Board C | - | - | - | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  |  |  | Board D | - | - | - | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  |  |  | Board E | - | - | - | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

*1. Test environment: compliance with JEDEC STANDARD JESD51-2A
Remark Refer to "■ Power Dissipation" and "Test Board" for details.

## ■ Electrical Characteristics

For details about the test circuits and testing method, refer to "■ Test Circuit".
Caution Unless otherwise specified in Table 8 and Table 9, set V2 = V3 = 0 V, and SWn ( $\mathrm{n}=1$ to 4) $=0$ FF.

1. $\mathrm{Ta}=+25^{\circ} \mathrm{C}$

Table 8 (1 / 2)
( $\mathrm{Ta}=+25^{\circ} \mathrm{C}$ unless otherwise specified)

| Item | Symbol | Condition |  | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Detection voltage |  |  |  |  |  |  |  |
| Cell balancing detection voltage | Vbu | SW1 = ON | $2.0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{BU}}<2.4 \mathrm{~V}$ | $\begin{aligned} & \hline \mathrm{V}_{\mathrm{BU}}- \\ & 0.012 \end{aligned}$ | Vbu | $\begin{aligned} & \hline \mathrm{V}_{\mathrm{BU}}+ \\ & 0.012 \end{aligned}$ | V |
|  |  |  | $2.4 \mathrm{~V} \leq \mathrm{V}_{\text {BU }} \leq 4.6 \mathrm{~V}$ | $\begin{aligned} & \hline V_{\text {BU }} \times \\ & 0.995 \end{aligned}$ | Vbu | $\begin{aligned} & \hline V_{\text {BU }} \times \\ & 1.005 \end{aligned}$ | V |
| Cell balancing release voltage | $V_{B L}$ | SW1 = ON | $2.0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{BL}}<2.4 \mathrm{~V}$ | $\begin{aligned} & \hline \mathrm{V}_{\mathrm{BL}}- \\ & 0.024 \end{aligned}$ | Vbl | $\begin{aligned} & \hline \mathrm{V}_{\mathrm{BL}}+ \\ & 0.024 \end{aligned}$ | V |
|  |  |  | $2.4 \mathrm{~V} \leq \mathrm{V}_{\mathrm{BL}} \leq 4.6 \mathrm{~V}$ | $\begin{gathered} \hline \text { VBL } \times \\ 0.99 \\ \hline \end{gathered}$ | VBL | $\begin{gathered} \hline V_{B L} \times \\ 1.01 \\ \hline \end{gathered}$ | V |
| Overcharge detection voltage | Vcu | $2.0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{cu}}<2.4 \mathrm{~V}$ |  | $\begin{aligned} & \hline V_{c u}- \\ & 0.012 \\ & \hline \end{aligned}$ | Vcu | $\begin{aligned} & \hline \text { Vcu }+ \\ & 0.012 \\ & \hline \end{aligned}$ | V |
|  |  | $2.4 \mathrm{~V} \leq \mathrm{Vcu} \leq 4.6 \mathrm{~V}$ |  | $\begin{aligned} & \hline \text { Vcu } \times \\ & 0.995 \end{aligned}$ | Vcu | $\begin{aligned} & \hline \text { Vcu } \times \\ & 1.005 \end{aligned}$ | V |
| Overcharge release voltage | VcL | $2.0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{cL}}<2.4 \mathrm{~V}$ |  | $\begin{aligned} & \hline \mathrm{V}_{\mathrm{CL}}- \\ & 0.024 \\ & \hline \end{aligned}$ | VCL | $\begin{aligned} & \hline V_{C L}+ \\ & 0.024 \\ & \hline \end{aligned}$ | V |
|  |  | $2.4 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CL}} \leq 4.6 \mathrm{~V}$ |  | $\begin{gathered} \hline \mathrm{V}_{\mathrm{CL}} \times \\ 0.99 \\ \hline \end{gathered}$ | Vcl | $\begin{gathered} \hline \mathrm{V}_{\mathrm{CL}} \times \\ 1.01 \\ \hline \end{gathered}$ | V |
| Input voltage |  |  |  |  |  |  |  |
| Operation voltage between VDD pin and VSS pin | $V_{\text {DS }}$ | Voltages outpu CB pin are fix | tput from CO pin and fixed | 1.5 | - | 5.0 | V |
| $\overline{\mathrm{CE}}$ pin voltage "H" | $\mathrm{V}_{\text {CEH }}$ |  | - | - | - | $\begin{gathered} \hline \operatorname{VDD} \times \\ 0.9 \end{gathered}$ | V |
| $\overline{\mathrm{CE}}$ pin voltage "L" | V $\mathrm{CEL}^{\text {c }}$ |  | - | $\begin{gathered} \hline \mathrm{V}_{\mathrm{DD}} \times \\ 0.1 \\ \hline \end{gathered}$ | - | - | V |
| DP pin voltage " H " | VDPH |  | - | - | - | $\begin{gathered} \hline \mathrm{V}_{\mathrm{DD}} \times \\ 0.9 \end{gathered}$ | V |
| DP pin voltage "L" | V DPL |  | - | $\begin{gathered} \hline \mathrm{V}_{\mathrm{DD}} \times \\ 0.1 \\ \hline \end{gathered}$ | - | - | V |
| Input current |  |  |  |  |  |  |  |
| Current consumption during operation | Iope | Ivdo when V | $1=\mathrm{V}_{\mathrm{BL}}-0.1 \mathrm{~V}$ | - | 1.2 | 2.0 | $\mu \mathrm{A}$ |
| Current consumption during power-saving | Ipsv | Ivdo when V | $1=\mathrm{V} 2=\mathrm{V}_{\mathrm{BL}}-0.1 \mathrm{~V}$ | - | - | 0.1 | $\mu \mathrm{A}$ |

Table 8 (2 / 2)

| Item | Symbol | Condition | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Delay time |  |  |  |  |  |  |
| Cell balancing detection delay time | $t_{B U}$ | - | tbu $\times 0.8$ | $t_{B U}$ | tbu $\times 1.2$ | ms |
| Cell balancing release delay time | tBL | - | tbl $\times 0.8$ | tbl | tbl $\times 1.2$ | ms |
| Overcharge detection delay time | tcu | - | tcu $\times 0.8$ | tcu | tcu $\times 1.2$ | ms |
| Overcharge release delay time | tcL | - | tcL $\times 0.8$ | tcL | tcl $\times 1.2$ | ms |
| Output current |  |  |  |  |  |  |
| CB pin output current |  |  |  |  |  |  |
| CB pin sink current | Icbs | $\begin{aligned} & \mathrm{V} 1=\mathrm{V}_{\mathrm{BU}}+0.1 \mathrm{~V}, \mathrm{SW} 2=\mathrm{ON}, \\ & \mathrm{~V} 4=0.5 \mathrm{~V} \end{aligned}$ | 30 | - | - | mA |
| CB pin leakage current | Icbl | $\begin{aligned} & \mathrm{V} 1=\mathrm{V} \text { BL }-0.1 \mathrm{~V}, \mathrm{SW} 2=\mathrm{ON}, \\ & \mathrm{~V} 4=6.0 \mathrm{~V} \end{aligned}$ | - | - | 0.1 | $\mu \mathrm{A}$ |
| CO pin output current (output form: CMOS output, output logic: active "H") |  |  |  |  |  |  |
| CO pin sink current | Icol | $\begin{aligned} & \mathrm{V} 1=\mathrm{V}_{\mathrm{CL}}-0.1 \mathrm{~V}, \mathrm{SW} 4=\mathrm{ON}, \\ & \mathrm{~V} 5=0.5 \mathrm{~V} \end{aligned}$ | 5.0 | - | - | mA |
| CO pin source current | Ісон | $\begin{aligned} & \mathrm{V} 1=\mathrm{V}_{\mathrm{Cu}}+0.1 \mathrm{~V}, \mathrm{SW} 4=\mathrm{ON}, \\ & \mathrm{~V} 5=\mathrm{V} 1-0.5 \mathrm{~V} \end{aligned}$ | 1.0 | - | - | mA |
| CO pin output current (output form: CMOS output, output logic: active "L") |  |  |  |  |  |  |
| CO pin sink current | Icol | $\begin{aligned} & \mathrm{V} 1=\mathrm{V} c u+0.1 \mathrm{~V}, \mathrm{SW} 4=\mathrm{ON}, \\ & \mathrm{~V} 5=0.5 \mathrm{~V} \end{aligned}$ | 5.0 | - | - | mA |
| CO pin source current | Ісон | $\begin{aligned} & \mathrm{V} 1=\mathrm{V} \mathrm{CL}-0.1 \mathrm{~V}, \mathrm{SW} 4=\mathrm{ON}, \\ & \mathrm{~V} 5=\mathrm{V} 1-0.5 \mathrm{~V} \end{aligned}$ | 1.0 | - | - | mA |
| CO pin output current (output form: Nch open-drain output, output logic: active "H") |  |  |  |  |  |  |
| CO pin sink current | Icol | $\begin{aligned} & \mathrm{V} 1=\mathrm{V} \mathrm{CL}-0.1 \mathrm{~V}, \mathrm{SW} 4=\mathrm{ON}, \\ & \mathrm{~V} 5=0.5 \mathrm{~V} \end{aligned}$ | 5.0 | - | - | mA |
| CO pin leakage current | Ісонц | $\begin{aligned} & \mathrm{V} 1=\mathrm{Vcu}+0.1 \mathrm{~V}, \mathrm{SW} 4=\mathrm{ON}, \\ & \mathrm{~V} 5=6.0 \mathrm{~V} \end{aligned}$ | - | - | 0.1 | $\mu \mathrm{A}$ |
| CO pin output current (output form: Nch open-drain output, output logic: active "L") |  |  |  |  |  |  |
| CO pin sink current | Icol | $\begin{aligned} & \mathrm{V} 1=\mathrm{V} c u+0.1 \mathrm{~V}, \mathrm{SW} 4=\mathrm{ON}, \\ & \mathrm{~V} 5=0.5 \mathrm{~V} \end{aligned}$ | 5.0 | - | - | mA |
| CO pin leakage current | Icohl | $\begin{aligned} & \mathrm{V} 1=\mathrm{VcL}-0.1 \mathrm{~V}, \mathrm{SW} 4=\mathrm{ON}, \\ & \mathrm{~V} 5=6.0 \mathrm{~V} \end{aligned}$ | - | - | 0.1 | $\mu \mathrm{A}$ |

## 2. $\mathrm{Ta}=-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$

Table 9 (1 / 2)
( $\mathrm{Ta}=-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$ unless otherwise specified)

| Item | Symbol | Condition |  | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Detection voltage |  |  |  |  |  |  |  |
| Cell balancing detection voltage | $V_{B u}$ | SW1 = ON | $2.0 \mathrm{~V} \leq \mathrm{V}_{\text {BU }}<2.4 \mathrm{~V}$ | $\begin{aligned} & \hline \mathrm{V}_{\text {BU }}- \\ & 0.040 \end{aligned}$ | Vbu | $\begin{aligned} & \hline \mathrm{V}_{\text {BU }}+ \\ & 0.040 \end{aligned}$ | V |
|  |  |  | $2.4 \mathrm{~V} \leq \mathrm{V}_{\text {BU }} \leq 4.6 \mathrm{~V}$ | $\begin{aligned} & \hline \text { V ви } \times \\ & 0.984 \end{aligned}$ | Vbu | $\begin{aligned} & \hline \text { Vвu } \times \\ & 1.016 \end{aligned}$ | V |
| Cell balancing release voltage | Vbl | SW1 = ON | $2.0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{BL}}<2.4 \mathrm{~V}$ | $\begin{aligned} & \hline V_{\text {BL }}- \\ & 0.080 \\ & \hline \end{aligned}$ | Vbl | $\begin{aligned} & \hline V_{\text {BL }}+ \\ & 0.080 \\ & \hline \end{aligned}$ | V |
|  |  |  | $2.4 \mathrm{~V} \leq \mathrm{V}_{\text {BL }} \leq 4.6 \mathrm{~V}$ | $\begin{aligned} & \hline V_{B L} \times \\ & 0.968 \\ & \hline \end{aligned}$ | $V_{\text {bL }}$ | $\begin{aligned} & \hline V_{B L} \times \\ & 1.032 \\ & \hline \end{aligned}$ | V |
| Overcharge detection voltage | Vcu | $2.0 \mathrm{~V} \leq \mathrm{V}_{\text {cu }}<2.4 \mathrm{~V}$ |  | $\begin{aligned} & \hline \mathrm{V}_{\mathrm{cu}}- \\ & 0.040 \\ & \hline \end{aligned}$ | Vcu | $\begin{aligned} & \hline \mathrm{V}_{\mathrm{cu}}+ \\ & 0.040 \\ & \hline \end{aligned}$ | V |
|  |  | $2.4 \mathrm{~V} \leq \mathrm{V}_{\text {cu }} \leq 4.6 \mathrm{~V}$ |  | $\begin{aligned} & \mathrm{V}_{\mathrm{cu}} \times \\ & 0.984 \\ & \hline \end{aligned}$ | Vcu | $\begin{aligned} & \hline V_{c u} \times \\ & 1.016 \\ & \hline \end{aligned}$ | V |
| Overcharge release voltage | $\mathrm{V}_{\text {cL }}$ | $2.0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CL}}<2.4 \mathrm{~V}$ |  | $\begin{aligned} & \hline \mathrm{V}_{\mathrm{CL}}- \\ & 0.080 \\ & \hline \end{aligned}$ | VcL | $\begin{aligned} & \hline \mathrm{V}_{\mathrm{CL}}+ \\ & 0.080 \end{aligned}$ | V |
|  |  | $2.4 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CL}} \leq 4.6 \mathrm{~V}$ |  | $\begin{aligned} & \hline V_{C L} \times \\ & 0.968 \end{aligned}$ | VCL | $\begin{aligned} & \hline V_{C L} \times \\ & 1.032 \end{aligned}$ | V |
| Input voltage |  |  |  |  |  |  |  |
| Operation voltage between VDD pin and VSS pin | $V_{\text {DS }}$ | Voltages out CB pin are | tput from CO pin and fixed | 1.5 | - | 5.0 | V |
| CE pin voltage "H" | $\mathrm{V}_{\text {CEH }}$ |  | - | - | - | $\begin{gathered} \mathrm{V}_{\mathrm{DD}} \times \\ 0.9 \\ \hline \end{gathered}$ | V |
| $\overline{C E}$ pin voltage "L" | $\mathrm{V}_{\text {CEL }}$ |  | - | $\begin{gathered} \hline \mathrm{VDD} \times \\ 0.1 \\ \hline \end{gathered}$ | - | - | V |
| DP pin voltage "H" | VDPH |  | - | - | - | $\begin{gathered} \mathrm{VDD} \times \\ 0.9 \\ \hline \end{gathered}$ | V |
| DP pin voltage "L" | V ${ }_{\text {dPL }}$ |  | - | $\begin{gathered} \mathrm{VDD} \times \\ 0.1 \\ \hline \end{gathered}$ | - | - | V |
| Input current |  |  |  |  |  |  |  |
| Current consumption during operation | Iope | Ivdo when V1 | $1=V_{B L}-0.1 \mathrm{~V}$ | - | 1.2 | 2.1 | $\mu \mathrm{A}$ |
| Current consumption during power-saving | Ipsv | Ivdo when V1 | $\mathrm{V} 1=\mathrm{V} 2=\mathrm{V}_{\text {BL }}-0.1 \mathrm{~V}$ | - | - | 0.15 | $\mu \mathrm{A}$ |

Table 9 (2 / 2)
( $\mathrm{Ta}=-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$ unless otherwise specified)

| Item | Symbol | Condition | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Delay time |  |  |  |  |  |  |
| Cell balancing detection delay time | $\mathrm{t}_{\text {Bu }}$ | - | tbu $\times 0.5$ | $t_{B u}$ | tbu $\times 1.5$ | ms |
| Cell balancing release delay time | tbL | - | tbl $\times 0.5$ | tbl | tbl $\times 1.5$ | ms |
| Overcharge detection delay time | tcu | - | tcu $\times 0.5$ | tcu | tcu $\times 1.5$ | ms |
| Overcharge release delay time | tcL | - | tcL $\times 0.5$ | tcL | tcl $\times 1.5$ | ms |
| Output current |  |  |  |  |  |  |
| CB pin output current |  |  |  |  |  |  |
| CB pin sink current | Icbs | $\begin{aligned} & \mathrm{V} 1=\mathrm{V}_{\mathrm{B}}+0.1 \mathrm{~V}, \mathrm{SW} 2=\mathrm{ON}, \\ & \mathrm{~V} 4=0.5 \mathrm{~V} \end{aligned}$ | 30 | - | - | mA |
| CB pin leakage current | Icbl | $\begin{aligned} & \mathrm{V} 1=\mathrm{V}_{\mathrm{BL}}-0.1 \mathrm{~V}, \mathrm{SW} 2=\mathrm{ON}, \\ & \mathrm{~V} 4=6.0 \mathrm{~V} \end{aligned}$ | - | - | 0.15 | $\mu \mathrm{A}$ |
| CO pin output current (output form: CMOS output, output logic: active "H") |  |  |  |  |  |  |
| CO pin sink current | Icol | $\begin{aligned} & \mathrm{V} 1=\mathrm{V} \mathrm{CL}-0.1 \mathrm{~V}, \mathrm{SW} 4=\mathrm{ON}, \\ & \mathrm{~V} 5=0.5 \mathrm{~V} \end{aligned}$ | 5.0 | - | - | mA |
| CO pin source current | Ісон | $\begin{aligned} & \mathrm{V} 1=\mathrm{V} \mathrm{Cu}+0.1 \mathrm{~V}, \mathrm{SW} 4=\mathrm{ON}, \\ & \mathrm{~V} 5=\mathrm{V} 1-0.5 \mathrm{~V} \end{aligned}$ | 1.0 | - | - | mA |
| CO pin output current (output form: CMOS output, output logic: active "L") |  |  |  |  |  |  |
| CO pin sink current | Icol | $\begin{aligned} & \mathrm{V} 1=\mathrm{V} c u+0.1 \mathrm{~V}, \mathrm{SW} 4=\mathrm{ON}, \\ & \mathrm{~V} 5=0.5 \mathrm{~V} \end{aligned}$ | 5.0 | - | - | mA |
| CO pin source current | Ісон | $\begin{aligned} & \mathrm{V} 1=\mathrm{V} \mathrm{CL}-0.1 \mathrm{~V}, \mathrm{SW} 4=\mathrm{ON}, \\ & \mathrm{~V} 5=\mathrm{V} 1-0.5 \mathrm{~V} \end{aligned}$ | 1.0 | - | - | mA |
| CO pin output current (output form: Nch open-drain output, output logic: active "H") |  |  |  |  |  |  |
| CO pin sink current | Icol | $\begin{aligned} & \mathrm{V} 1=\mathrm{VCL}-0.1 \mathrm{~V}, \mathrm{SW} 4=\mathrm{ON}, \\ & \mathrm{~V} 5=0.5 \mathrm{~V} \end{aligned}$ | 5.0 | - | - | mA |
| CO pin leakage current | I'Ohl | $\begin{aligned} & \mathrm{V} 1=\mathrm{V} c u+0.1 \mathrm{~V}, \mathrm{SW} 4=\mathrm{ON}, \\ & \mathrm{~V} 5=6.0 \mathrm{~V} \end{aligned}$ | - | - | 0.15 | $\mu \mathrm{A}$ |
| CO pin output current (output form: Nch open-drain output, output logic: active "L") |  |  |  |  |  |  |
| CO pin sink current | Icol | $\begin{aligned} & \mathrm{V} 1=\mathrm{V} c u+0.1 \mathrm{~V}, \mathrm{SW} 4=\mathrm{ON}, \\ & \mathrm{~V} 5=0.5 \mathrm{~V} \end{aligned}$ | 5.0 | - | - | mA |
| CO pin leakage current | Icohl | $\begin{aligned} & \mathrm{V} 1=\mathrm{VCL}-0.1 \mathrm{~V}, \mathrm{SW} 4=\mathrm{ON}, \\ & \mathrm{~V} 5=6.0 \mathrm{~V} \end{aligned}$ | - | - | 0.15 | $\mu \mathrm{A}$ |

## ■ Test Circuit



Figure 3
Caution Unless otherwise specified in Table 8, set V2 = V3 = 0 V, and SWn ( $\mathrm{n}=1$ to 4 ) $=$ OFF.

1. $\overline{C E}$ pin voltage " H "
$\overline{\mathrm{CE}}$ pin voltage " H " ( $\mathrm{V} \overline{\mathrm{CE}})$ ) is defined as the voltage at which IVDD is changed from lope to IPsV when V 2 is increased from 0 V after setting $\mathrm{V} 1=\mathrm{V}_{\mathrm{BL}}-0.1 \mathrm{~V}$.
2. $\overline{C E}$ pin voltage "L"
$\overline{\mathrm{CE}}$ pin voltage " L " ( $\mathrm{V}_{\overline{\mathrm{CEL}}}$ ) is defined as the voltage at which IVDD is changed from IPsv to lope when V 2 is decreased from $\mathrm{V}_{\mathrm{BL}}-0.1 \mathrm{~V}$ after setting $\mathrm{V} 1=\mathrm{V} 2=\mathrm{V}_{\mathrm{BL}}-0.1 \mathrm{~V}$.
3. DP pin voltage " $\mathrm{H}^{* * 1}$

DP pin voltage " H " (VDPH) is defined as the voltage at which the test mode is switched when V 3 is increased from 0 V after setting $\mathrm{V} 1=\mathrm{V}_{\mathrm{BL}}-0.1 \mathrm{~V}$.
4. DP pin voltage "L"*1

DP pin voltage " L " ( $V_{D P L}$ ) is defined as the voltage at which the normal operation mode is switched when V 3 is decreased from $\mathrm{V}_{\mathrm{BL}}-0.1 \mathrm{~V}$ after setting $\mathrm{V} 1=\mathrm{V} 3=\mathrm{V}_{\mathrm{BL}}-0.1 \mathrm{~V}$.
5. Cell balancing detection delay time

Cell balancing detection delay time ( $\mathrm{t}_{\mathrm{BU}}$ ) is defined as the time from when SW1 is set to ON and $\mathrm{V}_{1}$ is set to $\mathrm{V}_{B U}$ 0.1 V to when the CB pin output is inverted after setting V 1 to $\mathrm{V}_{B U}+0.1 \mathrm{~V}$.
6. Cell balancing release delay time

Cell balancing release delay time ( $\mathrm{t}_{\mathrm{bL}}$ ) is defined as the time from when SW1 is set to ON and V 1 is set to $\mathrm{V}_{\mathrm{BL}}+$ 0.1 V to when the CB pin output is inverted after setting V 1 to $\mathrm{V}_{\mathrm{BL}}-0.1 \mathrm{~V}$.
7. Overcharge detection delay time

Overcharge detection delay time (tcu) is defined as the time from when SW1 is set to ON and V1 is set to Vcu 0.1 V to when the CO pin output is inverted after setting V 1 to $\mathrm{V}_{c u}+0.1 \mathrm{~V}$.
8. Overcharge release delay time

Overcharge release delay time ( tcL ) is defined as the time from when SW1 is set to ON and V1 is set to VcL + 0.1 V to when the CO pin output is inverted after setting V 1 to $\mathrm{V}_{\mathrm{CL}}-0.1 \mathrm{~V}$.
*1. For details about switching to the test mode by using the DP pin, refer to "5. DP pin" in "■ Operation".

## Standard Circuit



Figure 4
Table 10 Constants for External Components

| Symbol | Part | Purpose | Min. | Typ. | Max. | Remark |
| :--- | :--- | :--- | :---: | :---: | :---: | :--- |
| RVDD | Resistor | ESD <br> protection, <br> for power <br> fluctuation <br> control | $150 \Omega$ | $330 \Omega$ | $1.0 \mathrm{k} \Omega$ | Resistance should be as small as possible to <br> avoid worsening the overcharge detection <br> accuracy due to current consumption."1 |
| CVDD | Capacitor | For power <br> fluctuation <br> control | $0.068 \mu \mathrm{~F}$ | $0.1 \mu \mathrm{~F}$ | $1.0 \mu \mathrm{~F}$ | Connect a capacitor of $0.068 \mu \mathrm{~F}$ or more <br> between VDD pin and VSS pin."1 |
| RCB | Resistor | For setting <br> the cell <br> balancing <br> current value | - | - | - | Set the required cell balancing current value <br> depending on "2. Cell balancing status" in <br> "■ Operation".*2 |

*1. When connecting a resistor less than $150 \Omega$ to Rvdd or a capacitor less than $0.068 \mu \mathrm{~F}$ to CvDD, the $\mathrm{S}-19190$ Series may malfunction when power is largely fluctuated.
*2. Set the cell balancing current value so that $\mathrm{R}_{\text {св }}$ does not exceed the power dissipation.

## Caution 1. The constants may be changed without notice.

2. It has not been confirmed whether the operation is normal or not in circuits other than the connection example. In addition, the connection example and the constants do not guarantee proper operation. Perform thorough evaluation using the actual application to set the constants.

## ■ Operation

## Remark Refer to "■ Standard Circuit ".

## 1. Normal status

In the S-19190 Series, if the voltage between the VDD pin and the VSS pin ( $V_{D S}$ ) has not reached the cell balancing detection voltage ( $\mathrm{V}_{\mathrm{BU}}$ ), the CB pin output is in the high-impedance status. The CO pin output status varies according to the output form and output logic selected, as shown in Table 11. This is the normal status.

Table 11

| CO Pin Output Form and Output Logic | CB Pin Output | CO Pin Output |
| :--- | :---: | :---: |
| CMOS output, active "H" | "H" | "L" |
| CMOS output, active "L" | "H" | "H" |
| Nch open-drain output, active "H" | "H" | "L" |
| Nch open-drain output, active "L" | "H" | "H" |

## 2. Cell balancing status

In the $\mathrm{S}-19190$ Series, if $\mathrm{V}_{\mathrm{DS}}$ is $\mathrm{V}_{\mathrm{BU}}$ or higher and this status continues for the cell balancing detection delay time (tbu) or longer, the CB pin output becomes "L". This is the cell balancing status.

The cell balancing status is released when Vds drops to the cell balancing release voltage ( $\mathrm{V}_{\mathrm{BL}}$ ) or lower and this status continues for the cell balancing release delay time (tвL) or longer.

The S-19190 Series includes an Nch transistor with ON resistance of $5 \Omega$ typ. (Rcвол) between the CB pin and the VSS pin, thus causing the cell balancing current (Ісв) to flow in cell balancing status, and the cell balancing operation to start.

By connecting a resistor ( $\mathrm{R}_{\mathrm{cB}}$ ) to the CB pin, $\mathrm{I}_{\text {св }}$ in cell balancing status can be calculated by using the following equation.


Figure 5

## 3. Overcharge status

In the $\mathrm{S}-19190$ Series, if $\mathrm{V}_{\mathrm{Ds}}$ is the overcharge detection voltage $\left(\mathrm{V}_{c u}\right)$ or higher and this status continues for the overcharge detection delay time (tcu) or longer, the CO pin output is inverted. The CO pin output status varies according to the output form and output logic selected, as shown in Table 12. This is the overcharge status. In the overcharge status, the CB pin output becomes "L".

Table 12

| CO Pin Output Form and Output Logic | CB Pin Output | CO Pin Output |
| :--- | :---: | :---: |
| CMOS output, active "H" | "L" | "H" |
| CMOS output, active "L" | "L" | "L" |
| Nch open-drain output, active "H" | "L" | "H" |
| Nch open-drain output, active "L" | "L" | "L" |

The overcharge status is released when $V_{D s}$ drops to the overcharge release voltage ( $\mathrm{V}_{\mathrm{CL}}$ ) or lower and this status continues for the overcharge release delay time ( tcL ) or longer.

## 4. $\overline{C E}$ pin

The S-19190 Series has the CE pin (Power-saving mode switching pin). The S-19190 Series is set to power-saving mode by inputting a voltage of $\mathrm{V}_{\text {CEH }}$ or higher to the CE pin.

Table 13

| $\overline{\mathrm{CE}}$ Pin | Status |
| :--- | :--- |
| Open $\left(\mathrm{V}_{\overline{\mathrm{CE}}}=\mathrm{V}_{\mathrm{Ss}}\right)$ | Normal operation mode |
| "H" $\left(\mathrm{V}_{\overline{\mathrm{CE}}} \geq \mathrm{V}_{\overline{\mathrm{CEH}}}\right)$ | Power-saving mode |
| "L" $\left(\mathrm{V}_{\overline{\mathrm{CE}}} \leq \mathrm{V}_{\overline{\mathrm{CEL}}}\right)$ | Normal operation mode |

In power-saving mode, the current consumption is decreased to current consumption during power-saving (lpsv). The CB pin or the CO pin output in power-saving mode is the same as that in the normal status.

The $\overline{C E}$ pin is pulled down to $V_{\text {ss }}$ by the internal resistor. When in a mode other than power-saving mode, leave the $\overline{\mathrm{CE}}$ pin open or short it with $\mathrm{V}_{\mathrm{ss}}$.

## 5. DP pin

The S-19190 Series has the DP pin (Test mode switching pin). The S-19190 Series is set to test mode (used to shorten the delay time) by inputting a voltage of $\mathrm{V}_{\mathrm{DPH}}$ or higher to the DP pin.

Table 14

| DP Pin | Status |
| :--- | :--- |
| Open $\left(V_{D P}=V_{\text {Ss }}\right)$ | Normal operation mode |
| "H" (VDP $\left.\geq V_{D P H}\right)$ | Test mode |
| "L" $\left(V_{D P} \leq V_{D P L}\right)$ | Normal operation mode |

In test mode, the cell balancing detection delay time ( $\mathrm{t}_{\mathrm{Bu}}$ ) and overcharge detection delay time ( tcu ) are shortened to $1 / 64$ of the delay time in the normal operation mode.

The DP pin is pulled down to $V_{\text {ss }}$ by the internal resistor. When in a mode other than test mode, leave the DP pin open or short it with Vss.

## ■ Timing Chart


*1. The CB pin is pulled up by the external resistor
*2. (1): Normal status
(2): Cell balancing status
(3): Overcharge status

Remark The charger is assumed to charge with a constant current.
Figure 6

## ■ Precautions

- The application conditions for the input voltage, output voltage, and load current should not exceed the power dissipation.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- ABLIC Inc. claims no responsibility for any and all disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.


## ■ Characteristics (Typical Data)

1. Current consumption

## 1. 1 Iope vs. Ta



1. 3 lope vs. VDD

2. 2 Ipsv vs. Ta

3. Cell balancing detection / release voltage, overcharge detection / release voltage and delay times
4. 1 VBu vs. Ta

5. $3 \mathrm{~V}_{\mathrm{cu}} \mathrm{vs}$. Ta

6. $2 \mathrm{~V}_{\mathrm{BL}}$ vs. Ta

7. 4 VCL vs. Ta


## 2. 5 t $_{B U}$ vs. Ta


2. 7 tcu vs. Ta


## 3. Output current

## 3. 1 Icbl vs. $V_{\text {cb }}$


3. 3 Iсон vs. Vco

2. 6 tblvs. Ta

2. 8 tcl vs. Ta

3. 2 Icbs vs. Vcb

3. 4 Icol vs. Vco


## ■ Power Dissipation

SOT-23-6


| Board | Power Dissipation (PD) |
| :---: | :---: |
| A | 0.63 W |
| B | 0.81 W |
| C | - |
| D | - |
| E | - |

## SOT-23-3/3S/5/6 Test Board

(1) Board A

IC Mount Area


| Item | Specification |  |
| :--- | :---: | :--- |
| Size $[\mathrm{mm}]$ | $114.3 \times 76.2 \times \mathrm{t1} .6$ |  |
| Material | FR-4 |  |
| Number of copper foil layer | 2 |  |
| Copper foil layer [mm] | 1 | Land pattern and wiring for testing: t0.070 |
|  | 2 | - |
|  | 3 | - |
|  | 4 | $74.2 \times 74.2 \times \mathrm{t0.070}$ |
| Thermal via |  |  |

(2) Board B


| Item | Specification |  |  |
| :--- | :--- | :--- | :---: |
| Size $[\mathrm{mm}]$ | $114.3 \times 76.2 \times \mathrm{t} 1.6$ |  |  |
| Material | FR-4 |  |  |
| Number of copper foil layer | 4 |  |  |
| Copper foil layer [mm] | 1 | Land pattern and wiring for testing: t0.070 |  |
|  | 2 | $74.2 \times 74.2 \times \mathrm{t0.035}$ |  |
|  | 3 | $74.2 \times 74.2 \times \mathrm{t0.035}$ |  |
|  | 4 | $74.2 \times 74.2 \times \mathrm{t0.070}$ |  |
| Thermal via |  |  |  |

No. SOT23x-A-Board-SD-2.0


| TITLE | SOT236-A-PKG Dimensions |
| :---: | :---: |
| No. | MP006-A-P-SD-2.1 |
| ANGLE | $\square$ |
| UNIT | mm |
|  |  |
|  |  |
| ABLIC Inc. |  |



No. MP006-A-C-SD-3. 1

| TITLE | SOT236-A-Carrier Tape |
| :---: | :---: |
| No. | MP006-A-C-SD-3.1 |
| ANGLE |  |
| UNIT | mm |
|  |  |
|  |  |
| ABLIC Inc. |  |



No. MP006-A-R-SD-2. 1

| TITLE | SOT236-A-Reel |  |  |
| :---: | :---: | :---: | :---: |
|  | MP006-A-R-SD-2.1 |  |  |
| ANGLE |  | QTY |  |
|  | 3,000 |  |  |
| UNIT | mm |  |  |
|  |  |  |  |
| ABLIC Inc. |  |  |  |

## Disclaimers (Handling Precautions)

1. All the information described herein (product data, specifications, figures, tables, programs, algorithms and application circuit examples, etc.) is current as of publishing date of this document and is subject to change without notice.
2. The circuit examples and the usages described herein are for reference only, and do not guarantee the success of any specific mass-production design.
ABLIC Inc. is not liable for any losses, damages, claims or demands caused by the reasons other than the products described herein (hereinafter "the products") or infringement of third-party intellectual property right and any other right due to the use of the information described herein.
3. ABLIC Inc. is not liable for any losses, damages, claims or demands caused by the incorrect information described herein.
4. Be careful to use the products within their ranges described herein. Pay special attention for use to the absolute maximum ratings, operation voltage range and electrical characteristics, etc.
ABLIC Inc. is not liable for any losses, damages, claims or demands caused by failures and / or accidents, etc. due to the use of the products outside their specified ranges.
5. Before using the products, confirm their applications, and the laws and regulations of the region or country where they are used and verify suitability, safety and other factors for the intended use.
6. When exporting the products, comply with the Foreign Exchange and Foreign Trade Act and all other export-related laws, and follow the required procedures.
7. The products are strictly prohibited from using, providing or exporting for the purposes of the development of weapons of mass destruction or military use. ABLIC Inc. is not liable for any losses, damages, claims or demands caused by any provision or export to the person or entity who intends to develop, manufacture, use or store nuclear, biological or chemical weapons or missiles, or use any other military purposes.
8. The products are not designed to be used as part of any device or equipment that may affect the human body, human life, or assets (such as medical equipment, disaster prevention systems, security systems, combustion control systems, infrastructure control systems, vehicle equipment, traffic systems, in-vehicle equipment, aviation equipment, aerospace equipment, and nuclear-related equipment), excluding when specified for in-vehicle use or other uses by ABLIC, Inc. Do not apply the products to the above listed devices and equipments.
ABLIC Inc. is not liable for any losses, damages, claims or demands caused by unauthorized or unspecified use of the products.
9. In general, semiconductor products may fail or malfunction with some probability. The user of the products should therefore take responsibility to give thorough consideration to safety design including redundancy, fire spread prevention measures, and malfunction prevention to prevent accidents causing injury or death, fires and social damage, etc. that may ensue from the products' failure or malfunction.
The entire system in which the products are used must be sufficiently evaluated and judged whether the products are allowed to apply for the system on customer's own responsibility.
10. The products are not designed to be radiation-proof. The necessary radiation measures should be taken in the product design by the customer depending on the intended use.
11. The products do not affect human health under normal use. However, they contain chemical substances and heavy metals and should therefore not be put in the mouth. The fracture surfaces of wafers and chips may be sharp. Be careful when handling these with the bare hands to prevent injuries, etc.
12. When disposing of the products, comply with the laws and ordinances of the country or region where they are used.
13. The information described herein contains copyright information and know-how of ABLIC Inc. The information described herein does not convey any license under any intellectual property rights or any other rights belonging to ABLIC Inc. or a third party. Reproduction or copying of the information from this document or any part of this document described herein for the purpose of disclosing it to a third-party is strictly prohibited without the express permission of ABLIC Inc.
14. For more details on the information described herein or any other questions, please contact ABLIC Inc.'s sales representative
15. This Disclaimers have been delivered in a text using the Japanese language, which text, despite any translations into the English language and the Chinese language, shall be controlling.

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components
Click to view similar products for Battery Management category:
Click to view products by Ablic manufacturer:

Other Similar products are found below :
MP26121DQ-LF-P NCP1855FCCT1G FAN54063UCX LC05132C01NMTTTG SN2040DSQR ME4075AM5G AP5054HTCER XPD977B XPD977B18 4056H DW01 DW06 CM1002-UD CM1002-W CM1002-X CM1002-Y CM1006-B CM1006-Q CM1006-WB CM1006-LCD CM1006-LBD CM1006-WF CM1006-LF CM1006-WG CM1006-WH CM1006-LG CM1003-S02BD CM1003-S09EA CM1003-S10ED CM1003-S11ED CM1003-S12BC CM1003-S13CC CM1003-S24BC CM1003-S26BC CM1003-WAD CM1003-BBD CM1003-BFD CM1003-BND CM1003-BLD CM1003-DAD CM1003-BMD CM1003-BPD CM1003-BKD CM1003-BAE CM1003-BHE CM1102B-FF CM1102B-FD CM1102B-GD CM1112-DAE CM1112-DBE

